



US00D546182S

(12) **United States Design Patent**
Hanji

(10) **Patent No.:** **US D546,182 S**
(45) **Date of Patent:** **** Jul. 10, 2007**

(54) **FLAT BLISTER PACKAGE**

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(73) Assignee: **Daido Metal Co., Ltd.**, Nagoya (JP)

(**) Term: **14 Years**

(21) Appl. No.: **29/266,810**

(22) Filed: **Sep. 28, 2006**

(51) **LOC (8) Cl.** **09-03**

(52) **U.S. Cl.** **D9/457; D9/415**

(58) **Field of Classification Search** D9/701,
D9/627, 628, 625, 624, 621, 622, 623, 457,
D9/456, 441, 434, 415, 414, 432; D5/99,
D5/7, 60, 58, 4, 12; D21/376; D20/25; 428/187;
40/642.01, 538, 124.1, 321, 360, 299.01;
283/81, 56; 273/292; 223/85; 206/767,
206/45.28, 449, 300, 440

See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

D16,217 S * 9/1885 Levy D21/376
D40,414 S * 12/1909 Valentine D5/60
D42,007 S * 12/1911 Avers D5/7
D95,070 S * 4/1935 Rivard D21/376

2,055,606 A * 9/1936 Klipfel D5/58
D117,431 S * 10/1939 Kaufman D5/60
D216,934 S * 3/1970 Hicks D5/58
D218,880 S * 10/1970 Conesa D9/432
D253,517 S * 11/1979 Grodin D9/432
D259,102 S * 5/1981 Grodin D9/414
D284,450 S * 7/1986 Suzuki et al. D9/432
D467,171 S * 12/2002 Hirokawa et al. D9/415
D468,198 S * 1/2003 Nakazawa et al. D9/415
7,185,761 B2 * 3/2007 Molina et al. 206/440
2005/0230961 A1 * 10/2005 Walley 283/81

* cited by examiner

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(57) **CLAIM**

The ornamental design for a flat blister package, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a flat blister package;
FIG. 2 is a front view of the flat blister package; and,
FIG. 3 is a rear elevational view of the flat blister package.

1 Claim, 3 Drawing Sheets

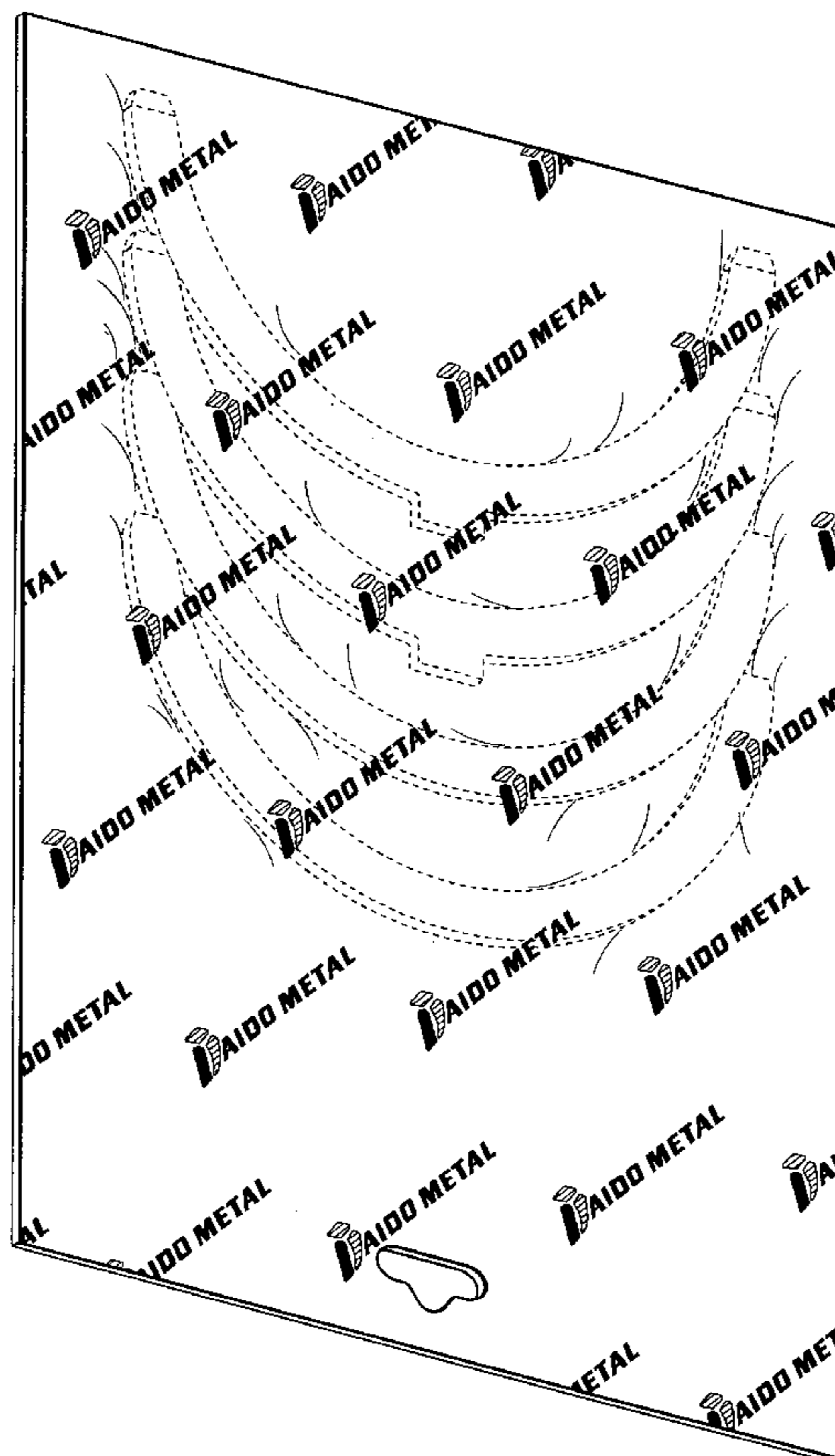


Fig. 1

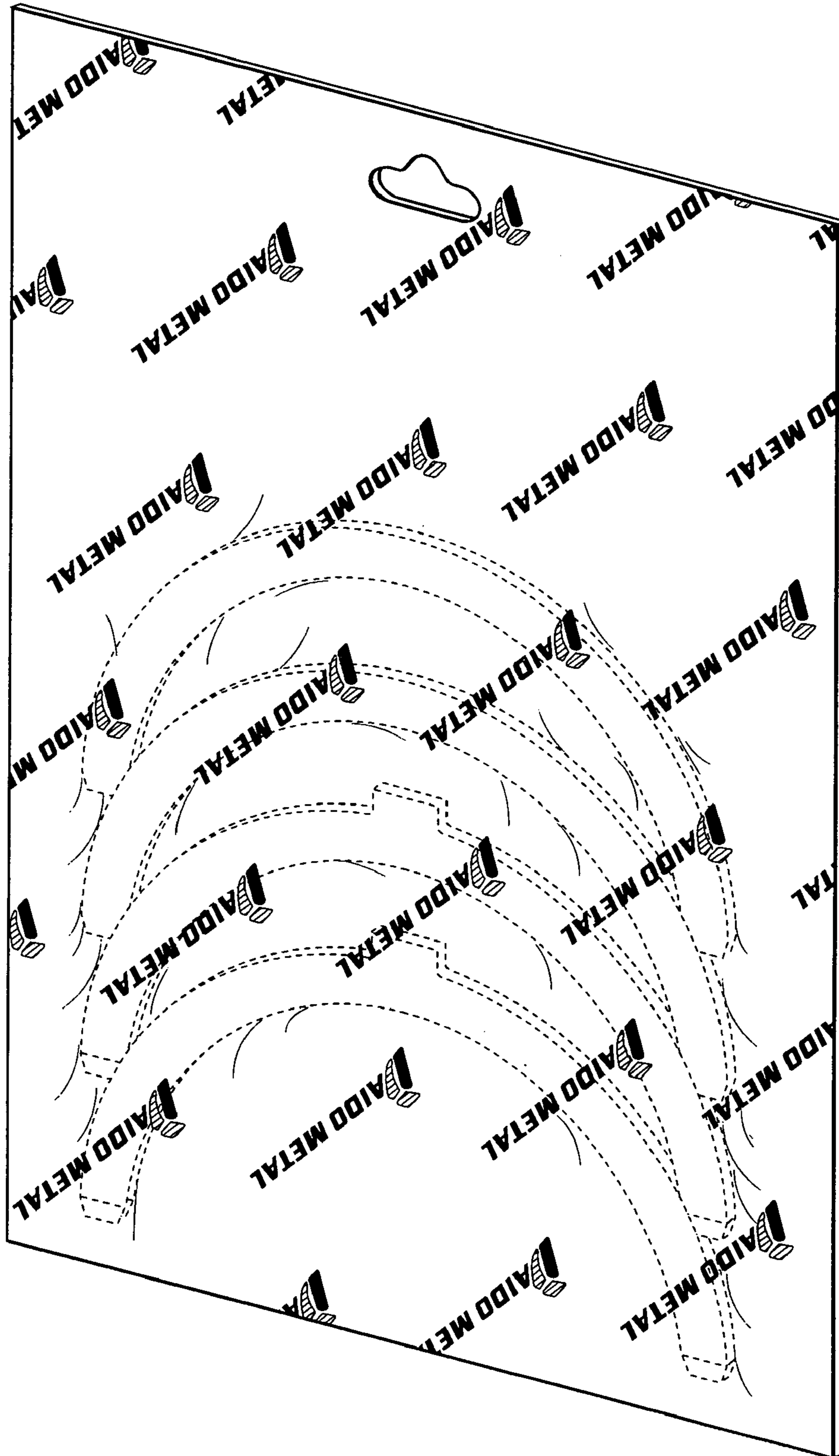


Fig. 2

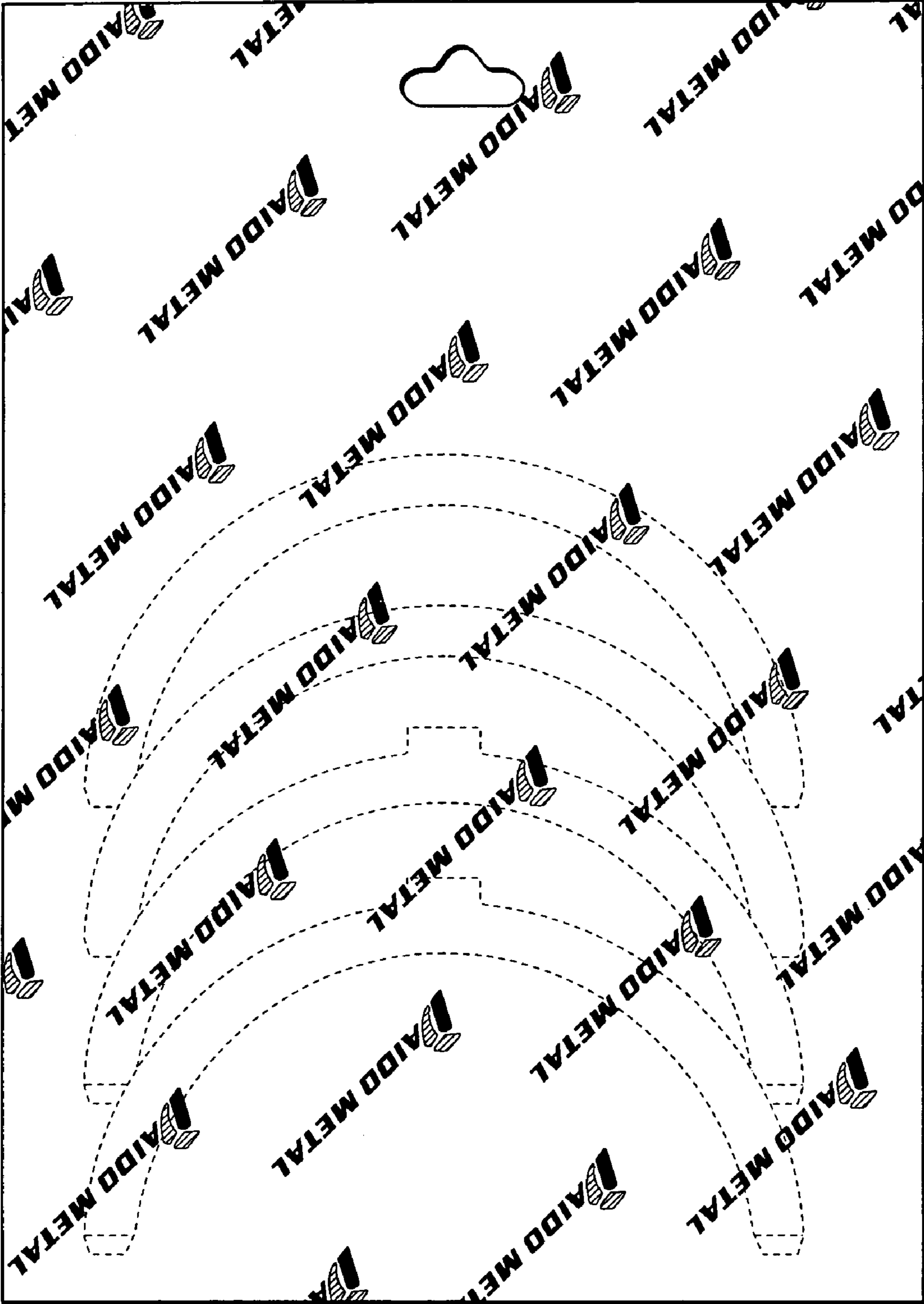


Fig. 3

